



# Product Change Notification

**Change Notification #:** 117528 - 01  
**Change Title:** Intel® NUC Kit, NUC8i3BEHS  
Intel® NUC Kit, NUC8i5BEHS,  
PCN 117528-01, Product Design, Label,  
BIOS and Label Update,  
**Reason for Revision: Include Post Change SA  
Numbers for i3 SKUs**  
**Date of Publication:** April 1, 2020

## Key Characteristics of the Change:

Product Design, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	April 10, 2020
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## Description of Change to the Customer:

### Reason for Revision: Include Post Change SA Numbers for i3 SKUs

The Intel® NUC Kit SKUs listed in the products affected table below will have the following changes.

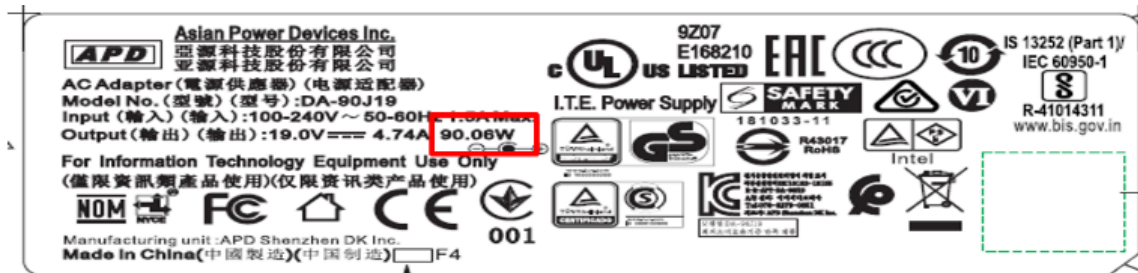
- The BIOS will be updated from version BECF357.86A.0076 to BECF357.86A.0077 for i5 SKUs. A complete list of BIOS changes can be found in the BIOS release notes. The BIOS updates and release notes can be found at <http://downloadcenter.intel.com>.
- Add BSMI LOGO on rating label. (New rating label attached below)



- Add KCC LOGO on WLAN label. Only for i5 SKU. (New WLAN label attached below.)



- Add Output power value on Adapter label. (New Adapter label attached below)



### Customer Impact of Change and Recommended Action:

These changes have been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BOXNUC8I5BEHS	999R17	K75956-302	K75953-302	K75956-303	K75953-303
BOXNUC8I5BEHS1	999R18	K75956-302	K75953-302	K75956-303	K75953-303
BOXNUC8I5BEHS2	999R1C	K75956-302	K75953-302	K75956-303	K75953-303
BOXNUC8I5BEHS6	999R1K	K75956-302	K75953-302	K75956-303	K75953-303
BOXNUC8I3BEHS	999R1L	K75960-301	K75955-301	K75960-302	NA
BOXNUC8I3BEHS1	999R1M	K75960-301	K75955-301	K75960-302	NA
BOXNUC8I3BEHS2	999R1N	K75960-301	K75955-301	K75960-302	NA
BOXNUC8I3BEHS6	999R1P	K75960-301	K75955-301	K75960-302	NA

## PCN Revision History:

**Date of Revision:**

March 30, 2020

[April 1, 2020](#)**Revision Number:**

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01

**Reason:**

Originally Published PCN

[Include Post Change SA Numbers for i3 SKUs](#)



# Product Change Notification

## 117528 - 01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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